# **BC212B**

# **Amplifier Transistors**

# **PNP Silicon**

### **Features**

• These are Pb-Free Devices\*

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	-50	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	-60	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	I <sub>C</sub>	-100	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	350 2.8	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

### THERMAL CHARACTERISTICS

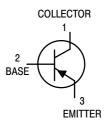
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	357	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	125	°C/W

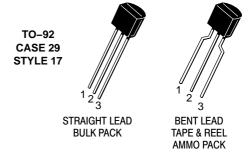
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



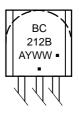
# ON Semiconductor®

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# **MARKING DIAGRAM**



A = Assembly Location

Y = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
BC212BG	TO-92 (Pb-Free)	5000 Units / Bulk
BC212BRL1G	TO-92 (Pb-Free)	2000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **BC212B**

# ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted) Characteristic

			1	Unit
V <sub>(BR)CEO</sub>	-50	-	-	Vdc
V <sub>(BR)CBO</sub>	-60	-	-	Vdc
V <sub>(BR)EBO</sub>	-5	-	-	Vdc
I <sub>CBO</sub>	-	-	-15	nAdc
I <sub>EBO</sub>	-	-	-15	nAdc
h <sub>FE</sub>	40	_	_	_
	60	-	-	
	-	120	-	
V <sub>CE(sat)</sub>	- -	-0.10 -0.25	_ _0.6	Vdc
V <sub>BE(sat)</sub>	-	-1.0	-1.4	Vdc
V <sub>BE(on)</sub>	-0.6	-0.62	-0.72	Vdc
DYNAMIC CHARACTERISTICS				
f <sub>T</sub>	_	280	_	MHz
C <sub>ob</sub>	-	-	6.0	pF
NF	-	-	10	dB
h <sub>fe</sub>	200	-	400	-
	V(BR)CBO V(BR)EBO ICBO IEBO  NFE  VCE(sat)  VBE(on)  fT  Cob  NF	V(BR)CBO -60  V(BR)EBO -5  ICBO -  IEBO -  hFE 40 60 -  VCE(sat) -  VBE(sat) -  VBE(on) -0.6	V(BR)CBO -60 -  V(BR)EBO -5 -  ICBO  IEBO  hFE 40 - 60 120  VCE(sat)0.10 - 0.25  VBE(sat)1.0  VBE(on) -0.6 -0.62	V(BR)CBO         -60         -         -           V(BR)EBO         -5         -         -           ICBO         -         -         -15           IEBO         -         -         -15           hFE         40         -         -           60         -         -         -           -         -         -         -           VCE(sat)         -         -         -           VBE(sat)         -         -         -           VBE(on)         -         -         -           fT         -         -         -           Cob         -         -         -           NF         -         -         10

<sup>1.</sup> Pulse Test: Tp 300 s, Duty Cycle 2.0%.

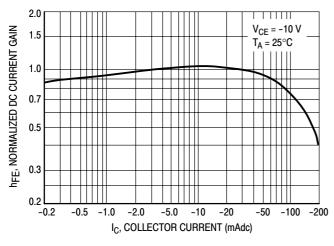


Figure 1. Normalized DC Current Gain

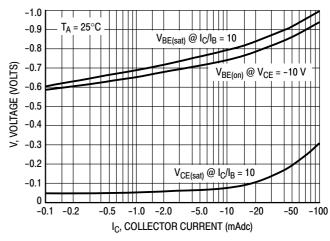


Figure 2. "Saturation" and "On" Voltages

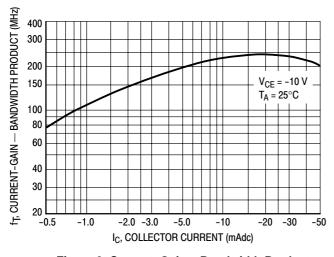


Figure 3. Current-Gain - Bandwidth Product

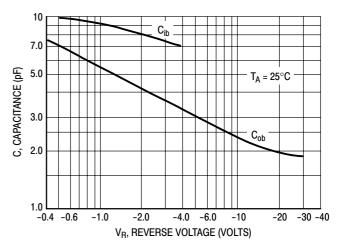


Figure 4. Capacitances

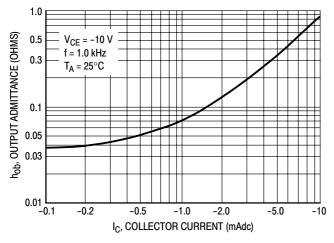


Figure 5. Output Admittance

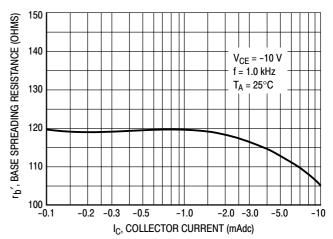
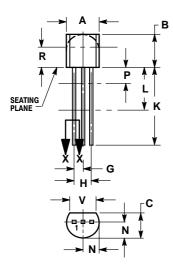


Figure 6. Base Spreading Resistance

## **BC212B**

#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 **ISSUE AM** 



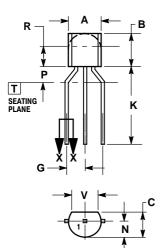
STRAIGHT LEAD **BULK PACK** 



### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	



**BENT LEAD** TAPE & REEL AMMO PACK



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
  CONTOUR OF PACKAGE BEYOND
- DIMENSION R IS UNCONTROLLED
- LEAD DIMENSION IS UNCONTROLLED IN PAND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.45	5.20	
В	4.32	5.33	
С	3.18	4.19	
D	0.40	0.54	
G	2.40	2.80	
J	0.39	0.50	
K	12.70		
N	2.04	2.66	
P	1.50	4.00	
R	2.93		
٧	3.43		

STYLE 17:

COLLECTOR PIN 1.

BASE

EMITTER

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